

**Preliminary Technical Data** 

# Omnidirectional Microphone with Bottom Port and Analog Output ADMP405

### FEATURES

Tiny 3.35 mm × 2.50 mm × 0.88 mm surface-mount package High SNR of 62 dBA High sensitivity of –38 dBV Flat frequency response from 200 Hz to 15 kHz Low current consumption: <250 μA Single-ended analog output High PSRR of 70 dB Compatible with Sn/Pb and Pb-free solder processes RoHS/WEEE compliant

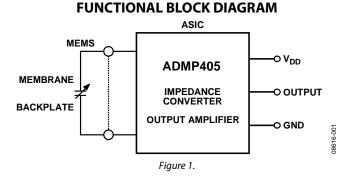
#### **APPLICATIONS**

Smartphones and feature phones Digital video cameras Bluetooth headsets Video phones Teleconferencing systems

#### **GENERAL DESCRIPTION**

The ADMP405 is a high quality, low cost, low power, analog output bottom-ported omnidirectional MEMS microphone. The ADMP405 consists of a MEMS microphone element, an impedance converter, and an output amplifier. The ADMP405 sensitivity specification makes it an excellent choice for both near field and far field applications. The ADMP405 has a high SNR and flat, wideband frequency response, resulting in natural sound with high intelligibility. The specially designed lowfrequency cutoff reduces wind noise. Low current consumption enables long battery life for portable applications. A built-in particle filter provides high reliability. The ADMP405 complies with the TIA-920 *Telecommunications Telephone Terminal Equipment Transmission Requirements for Wideband Digital Wireline Telephones* standard.

The ADMP405 is available in an ultraminiature 3.35 mm  $\times$  2.50 mm  $\times$  0.88 mm surface-mount package. It is reflow solder compatible with no sensitivity degradation. The ADMP405 is halide free.



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# Preliminary Technical Data

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### **SPECIFICATIONS**

 $T_A = 25^{\circ}$ C,  $V_{DD} = 1.8$  V, unless otherwise noted. All minimum and maximum specifications are guaranteed. Typical specifications are not guaranteed.

Table 1.

Parameter	Symbol	Test Conditions/Comments	Min	Тур	Max	Unit
PERFORMANCE						
Directionality				Omni		
Sensitivity		1 kHz, 94 dB SPL	-41	-38	-35	dBV
Signal-to-Noise Ratio	SNR			62		dBA
Equivalent Input Noise	EIN			32		dBA SPL
Frequency Response <sup>1</sup>		Low frequency –3 dB point		200		Hz
		High frequency –3 dB point		15		kHz
		Deviation from flat response within pass band	-3		+2	dB
Total Harmonic Distortion	THD	105 dB SPL			3	%
Power Supply Rejection Ratio	PSRR	217 Hz, 100 mV p-p square wave		70		dB
		superimposed on $V_{DD} = 1.8 V$				
Maximum Acoustic Input		Peak		120		dB SPL
POWER SUPPLY						
Supply Voltage	V <sub>DD</sub>		1.5		3.6	V
Supply Current	ls				250	μΑ
OUTPUT CHARACTERISTICS						
Output impedance	Zout			200		Ω
Output DC Offset				0.8		V
Output Current Limit				90		μΑ
Polarity				Noninverting <sup>2</sup>		

<sup>1</sup> See Figure 4 and Figure 6.

<sup>2</sup> Positive going (increasing) pressure on the membrane results in a positive going (increasing) output voltage.

### **ABSOLUTE MAXIMUM RATINGS**

#### Table 2.

Parameter	Rating
Supply Voltage	3.6 V
Sound Pressure Level (SPL)	160 dB
Mechanical Shock	10,000 <i>g</i>
Vibration	Per MIL-STD-883 Method 2007,
	Test Condition B
Temperature Range	–40°C to +70°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **ESD CAUTION**



**ESD** (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

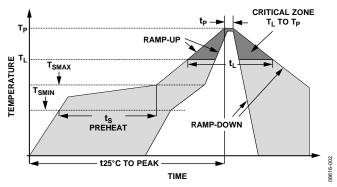


Figure 2. Recommended Soldering Profile Limits

#### Table 3. Recommended Soldering Profile Limits

Profile Feature	Sn63/Pb37	Pb-Free
Average Ramp Rate ( $T_L$ to $T_P$ )	3°C/sec max	3°C/sec max
Preheat		
Minimum Temperature (T <sub>SMIN</sub> )	100°C	150°C
Maximum Temperature (T <sub>SMAX</sub> )	150°C	200°C
Time (T <sub>SMIN</sub> to T <sub>SMAX</sub> ), ts	60 sec to 120 sec	60 sec to 120 sec
Ramp-Up Rate ( $T_{SMAX}$ to $T_L$ )	3°C/sec	3°C/sec
Time Maintained Above Liquidous (t <sub>L</sub> )	60 sec to 150 sec	60 sec to 150 sec
Liquidous Temperature (T <sub>L</sub> )	183°C	217°C
Peak Temperature (T <sub>P</sub> )	240°C + 0°C/-5°C	260°C + 0°C/-5°C
Time Within 5°C of Actual Peak Temperature (t <sub>P</sub> )	10 sec to 30 sec	20 sec to 40 sec
Ramp-Down Rate	6°C/sec max	6°C/sec max
Time 25°C (t25°C) to Peak Temperature	6 minute max	8 minute max

## **PIN CONFIGURATION AND FUNCTION DESCRIPTIONS**

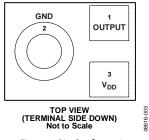


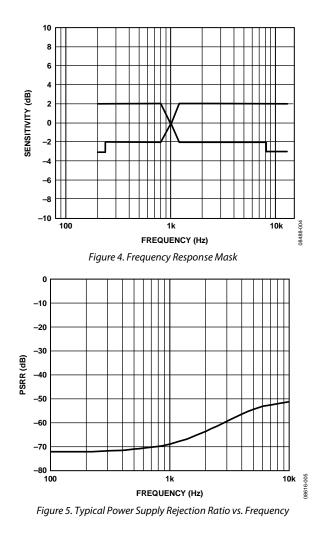
Figure 3. Pin Configuration

#### Table 4. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	OUTPUT	Analog Output Signal.
2	GND	Ground.
3	V <sub>DD</sub>	Power Supply.

## ADMP405

## **TYPICAL PERFORMANCE CHARACTERISTICS**



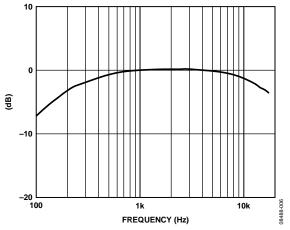


Figure 6. Typical Frequency Response (Measured)

### **APPLICATIONS INFORMATION**

The ADMP405 output can be connected to a dedicated codec microphone input (see Figure 7) or to a high input impedance gain stage (see Figure 8). A 0.1  $\mu$ F ceramic capacitor (C1) at V<sub>DD</sub> placed close to the ADMP405 supply pins is used for testing and is recommended to adequately decouple the microphone from noise on the power supply. A 1  $\mu$ F or larger dc-blocking tantalum capacitor (C2) is required at the output of the microphone.

#### **CONNECTING THE ADMP405 TO A CODEC**

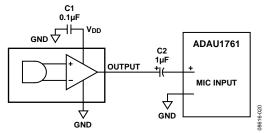


Figure 7. ADMP405 Connected to the Analog Devices ADAU1761 Codec

# CONNECTING THE ADMP405 TO AN OP AMP GAIN STAGE

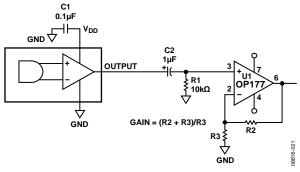


Figure 8. ADMP405 Connected to the OP177 Op Amp

### PCB LAND PATTERN LAYOUT

The recommended PCB land pattern for the ADMP405 should be laid out to a 1:1 ratio to the solder pads on the microphone package, as shown in Figure 9. Care should be taken to avoid applying solder paste to the sound hole in the PCB. A suggested solder paste stencil pattern layout is shown in Figure 10. The diameter of the sound hole in the PCB should be larger than the diameter of the sound port of the microphone. A minimum diameter of 0.5 mm is recommended.

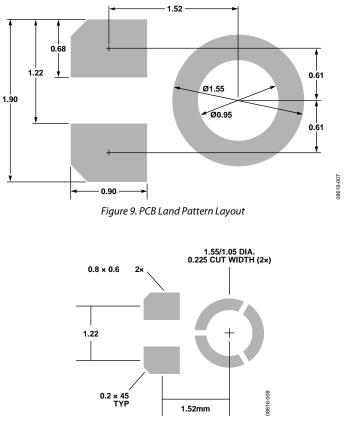


Figure 10. Suggested Solder Paste Stencil Pattern Layout

### HANDLING INSTRUCTIONS PICK AND PLACE EQUIPMENT

The MEMS microphone can be handled using standard pickand-place and chip shooting equipment. Care should be taken to avoid damage to the MEMS microphone structure as follows:

- Use a standard pickup tool to handle the microphone. Because the microphone hole is on the bottom of the package, the pickup tool can make contact with any part of the lid surface.
- Use care during pick-and-place to ensure that no high shock events above 20 kg are experienced because such events may cause damage to the microphone.
- Do not pick up the microphone with a vacuum tool that makes contact with the bottom side of the microphone. Do not pull air out of or blow air into the microphone port.
- Do not use excessive force to place the microphone on the PCB.

### **REFLOW SOLDER**

For best results, the soldering profile should be in accordance with the recommendations of the manufacturer of the solder paste used to attach the MEMS microphone to the PCB. It is recommended that the solder reflow profile not exceed the limit conditions specified in Figure 2 and Table 3.

#### **BOARD WASH**

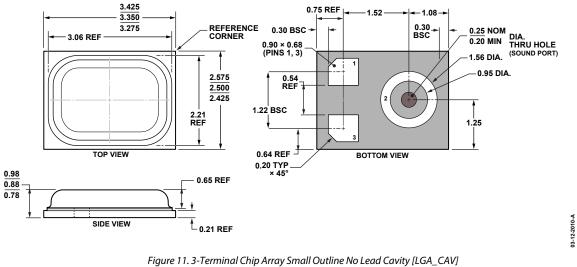
When washing the PCB, ensure that water does not make contact with the microphone port. Blow-off procedures and ultrasonic cleaning must not be used.

### **RELIABILITY SPECIFICATIONS**

The microphone sensitivity after stress must deviate by no more than  $\pm 3$  dB from the initial value.

Table 5.			
Stress Test	Description		
Low Temperature Operating Life	-40°C, 500 hours, powered		
High Temperature Operating Life	+125°C, 500 hours, powered		
ТНВ	+65°C/85% relative humidity (RH), 500 hours, powered		
Temperature Cycle	-40°C/+125°C, one cycle per hours, 100 cycles		
High Temperature Storage	+150°C, 500 hours		
Low Temperature Storage	-40°C, 500 hours		
Component CDM ESD	All pins, 0.5 kV		
Component HBM ESD	All pins, 1.5 kV		
Component MM ESD	All pins, 0.2 kV		

## **OUTLINE DIMENSIONS**



ure 11. 3-Terminal Chip Array Small Outline No Lead Cavity [LGA\_CA 3.35 mm × 2.50 mm Body (CE-3-2) Dimensions shown in millimeters

#### **ORDERING GUIDE**

<b>Model</b> <sup>1</sup>	Temperature Range	Package Description	Package Option	Ordering Quantity
ADMP405ACEZ	-40°C to +70°C	3-Terminal LGA_CAV	CE-3-2 <sup>2</sup>	1
ADMP405ACEZ-RL	-40°C to +70°C	3-Terminal LGA_CAV, 13" Tape and Reel	CE-3-2 <sup>2</sup>	10,000
ADMP405ACEZ-RL7	-40°C to +70°C	3-Terminal LGA_CAV, 7" Tape and Reel	CE-3-2 <sup>2</sup>	1,000
EVAL-ADMP405Z		Evaluation Board		

 $^{1}$  Z = RoHS Compliant Part.

<sup>2</sup> This package option is halide free.

### NOTES

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